

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Stephen W. Bedell	06/15/2004
Anthony G. Domenicucci	06/16/2004
Keith E. Fogel	06/15/2004
Effendi Leobandung	06/23/2004
Devendra K. Sadana	06/15/2004

RECEIVING PARTY DATA

Name:	International Business Machines Corporation
Street Address:	New Orchard Road
City:	Armonk
State/Country:	NEW YORK
Postal Code:	10504

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	10883883

CORRESPONDENCE DATA

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Total Attachments: 2

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PATENT
REEL: 015981 FRAME: 0857

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ASSIGNMENT

Whereas, we

Inventor and City	(1) Stephen W. Bedell County of Dutchess	City of Wappingers Falls and State of New York
and	(2) Anthony G. Domenicucci County of Ulster	City of New Paltz and State of New York
and	(3) Keith E. Fogel County of Westchester	City of Mohegan Lake and State of New York
and	(4) Effendi Leobandung County of Dutchess	City of Wappingers Falls and State of New York
and	(5) Devendra K. Sadana County of Westchester	City of Pleasantville and State of New York

have invented certain improvements in

Title ULTRA-THIN, HIGH QUALITY STRAINED SILICON-ON-INSULATOR FORMED BY ELASTIC STRAIN TRANSFER

Dates That
Inventors
Signed the
Declaration

and have executed, respectively, a United States patent application therefor on

(1) June 15	2004, and (2) June 16	2004, and
(3) June 15	2004, and (4) June 23	2004, and
(5) June 15,	2004.	

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

ASSIGNMENT

City (1) Signed at *Yorktown Heights, NY*
Date on *June 15, 2004* *Stephen W. Bedell* signature
(Stephen W. Bedell) inventor
First Name Middle Initial Last Name

City (2) Signed at *East Fishkill*
Date on *June 16, 2004* *Anthony G. Domenicucci* signature
(Anthony G. Domenicucci) inventor
First Name Middle Initial Last Name

City (3) Signed at *Yorktown Heights, NY*
Date on *June 15, 2004* *Keith E. Fogel* signature
(Keith E. Fogel) inventor
First Name Middle Initial Last Name

City (4) Signed at *East Fishkill*
Date on *June 23, 2004* *Effendi* signature
(Effendi Leobandung) inventor
First Name Middle Initial Last Name

City (5) Signed at *Yorktown Heights, NY*
Date on *June 15, 2004* *Devendra K. Sadana* signature
(Devendra K. Sadana) inventor
First Name Middle Initial Last Name